

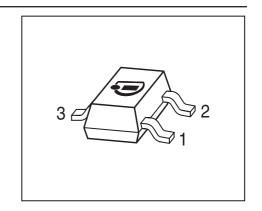


NPN Silicon High-Voltage Transistors

- Low collector-emitter saturation voltage
- Complementary types: SMBTA92 / MMBTA92(PNP)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101







Туре	Marking	Pin Configuration			Package
SMBTA42/MMBTA42	s1D	1=B	2=E	3=C	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	300	V
Collector-base voltage	V_{CBO}	300	
Emitter-base voltage	V_{EBO}	6	
Collector current	I _C	500	mA
Base current	I_{B}	100	
Total power dissipation-	P _{tot}	360	mW
<i>T</i> _S ≤ 74 °C			
Junction temperature	T _j	150	°C
Storage temperature	$T_{ m stg}$	-65 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	≤ 210	K/W

 $^{^{1}}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

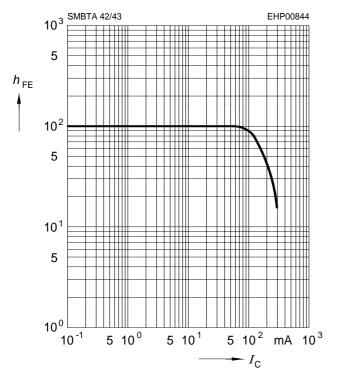
Parameter	Symbol		Values		
		min.	typ.	max.	
DC Characteristics			1	1	1
Collector-emitter breakdown voltage	V _{(BR)CEO}	300	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0					
Collector-base breakdown voltage	V _{(BR)CBO}	300	-	-	
$I_{\rm C}$ = 100 μ A, $I_{\rm E}$ = 0					
Emitter-base breakdown voltage	V _{(BR)EBO}	6	-	-	
$I_{\rm E}$ = 100 μ A, $I_{\rm C}$ = 0					
Collector-base cutoff current	I _{CBO}				μA
$V_{\rm CB}$ = 200 V, $I_{\rm E}$ = 0		-	-	0.1	
V_{CB} = 200 V, I_{E} = 0 , T_{A} = 150 °C		-	-	20	
Emitter-base cutoff current	I _{EBO}	-	-	100	nA
$V_{\rm EB} = 5 \rm V, I_{\rm C} = 0$					
DC current gain ¹⁾	h _{FE}				-
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V		25	-	-	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 10 V		40	-	-	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 10 V		40	-	-	
Collector-emitter saturation voltage ¹⁾	V _{CEsat}	-	-	0.5	V
$I_{\rm C}$ = 20 mA, $I_{\rm B}$ = 2 mA					
Base emitter saturation voltage ¹⁾	V _{BEsat}	-	-	0.9	
$I_{\rm C}$ = 20 mA, $I_{\rm B}$ = 2 mA					
AC Characteristics	-				
Transition frequency	f _T	50	70	-	MHz
$I_{\rm C}$ = 10 MHz, $V_{\rm CE}$ = 20 V, f = 100 MHz					
Collector-base capacitance	C _{cb}	-	-	3	pF
$V_{\text{CB}} = 20 \text{ V}, f = 1 \text{ MHz}$					

¹Pulse test: $t < 300\mu s$; D < 2%



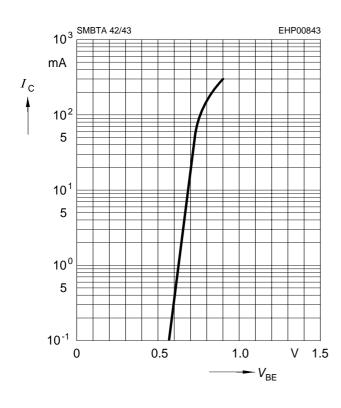
DC current gain $h_{FE} = f(I_C)$

$$V_{CE}$$
 = 10 V



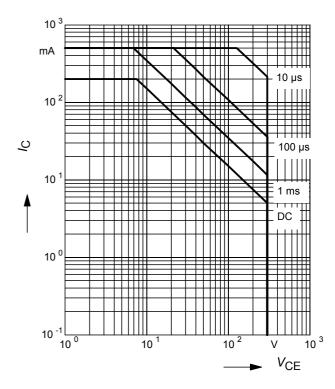
Collector current $I_{C} = f(V_{BE})$

$$V_{CE} = 10V$$



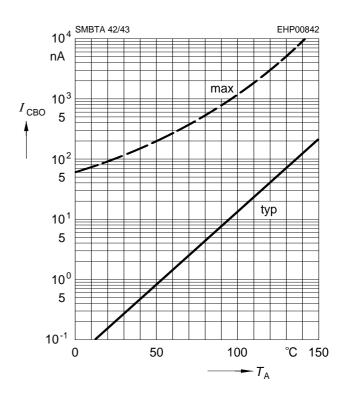
Operating range $I_{C} = f(V_{CEO})$

$$T_{A} = 25^{\circ}\text{C}, D = 0$$



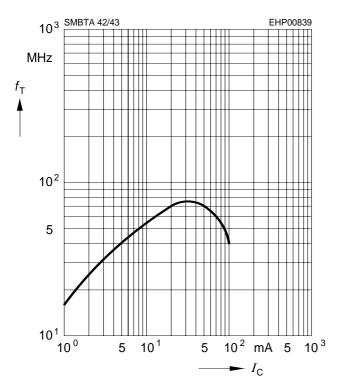
Collector cutoff current $I_{CBO} = f(T_A)$

$$V_{\rm CBO}$$
 = 160 V

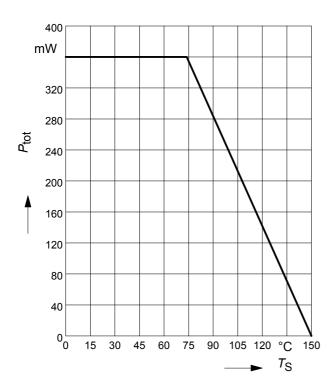




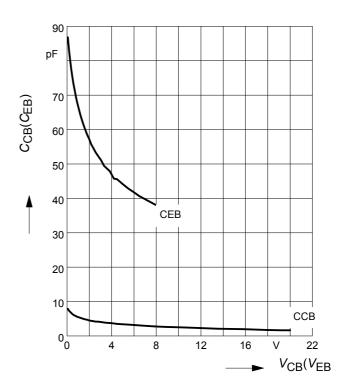
Transition frequency $f_T = f(I_C)$ $V_{CE} = 10 \text{ V}, f = 100 \text{ MHz}$



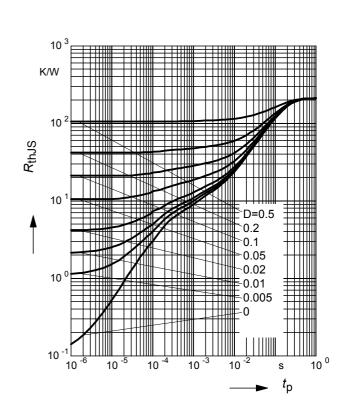
Total power dissipation $P_{tot} = f(T_S)$



Collector-base capacitance $C_{\text{cb}} = f(V_{\text{CB}})$ Emitter-base capacitance $C_{\text{eb}} = f(V_{\text{EB}})$



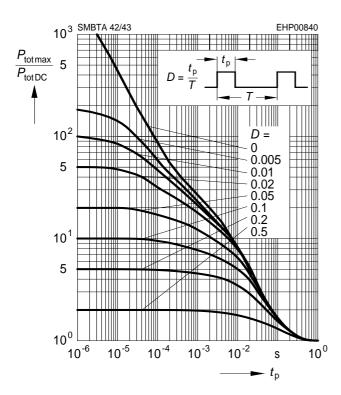
Permissible Pulse Load $R_{thJS} = f(t_p)$





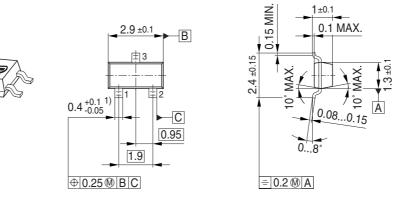
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$



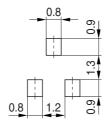


Package Outline

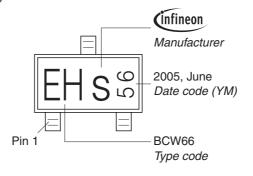


1) Lead width can be 0.6 max. in dambar area

Foot Print

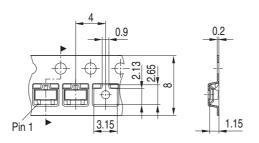


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





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